

National Semiconductor

NM93C06/C46/C56/C66 256-/1024-/2048-/4096-Bit Serial EEPROM (MICROWIRE™ Bus Interface)

General Description

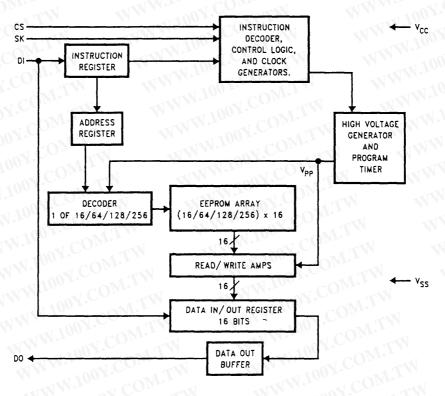
The NM93C06/C46/C56/C66 devices are 256/1024/2048/4096 bits, respectively, of CMOS non-volatile electrically erasable memory divided into 16/64/128/256 16-bit registers. They are fabricated using National Semiconductor's floating-gate CMOS process for high reliability and low power consumption. These memory devices are available in both SO and TSSOP packages for small space considerations.

The EEPROM Interfacing is MICROWIRE compatible for simple interface to standard microcontrollers and microprocessors. There are 7 instructions that control these devices: Read, Erase/Write Enable, Erase, Erase All, Write, Write All, and Erase/Write Disable. The ready/busy status is available on the DO pin during programming.

Features

- Device status during programming mode
- Typical active current of 200 μA; Typical standby current of 10 μA
- No erase required before write
- Reliable CMOS floating gate technology
- 4.5V to 5.5V operation in all modes
- MICROWIRE compatible serial I/O
- Self-timed programming cycle
- 40 years data retention
- Endurance: 106 data changes
- Packages available: 8-pin SO, 8-pin DIP, 8-pin TSSOP

Block Diagram

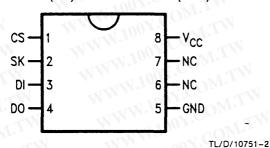


TL/D/10751-1

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Connection Diagrams

Dual-In-Line Package (N) 8-Pin SO (M8) and 8-Pin TSSOP (MT8)



0 7.

See NS Package Number N08E, M08A and MTC08

Top View

Pin Names

Chip Select
Serial Data Clock
Serial Data Input
Serial Data Output
Ground
Power Supply

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Ordering Information

Commercial Temp. Range (0°C to +70°C)

		.IIV 1 / . L '
Order Number	MMM	ON TW
NM93C06N/NM93C46N	WWW	TOOK CONT.
NM93C56N/NM93C66N		1.100 COM. 1
NM93C06M8/NM93C46M8		1100Y. OM.TV
NM93C56M8/NM93C66M8		W. CON. TY
NM93C06MT8/NM93C46MT8		M.Joe COM.
NM93C56MT8/NM93C66MT8		100 Y. COM.

Extended Temp. Range (-40°C to +85°C)

WT	Order Number	
WW	NM93C06EN/NM93C46EN	
	NM93C56EN/NM93C66EN	
	NM93C06EM8/NM93C46EM8	
	NM93C56EM8/NM93C66EM8	l
	NM93C06EMT8/NM93C46EMT8	
	NM93C56EMT8/NM93C66EMT8	

Automotive Temp. Range (-40°C to + 125°C)

NM93C06VN/NM93C46VN NM93C56VN/NM93C66VN
NM93C06VM8/NM93C46VM8
NM93C56VM8/NM93C66VM8
NM93C06VMT8/NM93C46VMT8
NM93C56VMT8/NM93C66VMT8

WW.100Y.COM.T

WWW.100Y.COM.T

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Ambient Storage Temperature

-65°C to +150°C

All Input or Output Voltages

+6.5V to -0.3V

with Respect to Ground

Lead Temp. (Soldering, 10 sec.)

ESD Rating

LM.

+300°C

Operating Conditions

Ambient Operating Temperature NM93C06-NM93C66 NM93C06E-NM93C66E

NM93C06V-NM93C66V Power Supply (V_{CC}) 0°C to +70°C -40°C to +85°C -40°C to +125°C

4.5V to 5.5V

DC and AC Electrical Characteristics $V_{CC} = 5.0V \pm 10\%$ unless otherwise specified

Note: Throughout this table, "M" refers to temperature range (-55° C to $+125^{\circ}$ C), not package.

Symbol	Parameter	Part Number	Conditions	Min	Max	Units
ICCA	Operating Current	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	$CS = V_{IH}$, $SK = 1 MHz$ SK = 1 MHz	OM.TW	1	mA
Iccs	Standby Current	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	CS = V _{IL}	CONTA	50 50	μA μA
l _{IL}	Input Leakage Output Leakage	MMM.1007.COW.L	V _{IN} = 0V to V _{CC} (Note 3)	I.COM.T	N ±1	μΑ
V _{IL} V _{IH}	Input Low Voltage Input High Voltage	MAMA: 100X:COM	IM MMM.10	-0.1 2	0.8 V _{CC} + 1	٧
V _{OL1} V _{OH1}	Output Low Voltage Output High Voltage	WWW.Ino.	$I_{OL} = 2.1 \text{ mA}$ $I_{OH} = -400 \mu\text{A}$	2.4	0.4	V V
V _{OL2} V _{OH2}	Output Low Voltage Output High Voltage	M.M.M.100X.C	$I_{OL} = 10 \mu A$ $I_{OH} = -10 \mu A$	V _{CC} - 0.2	0.2	٧
fsk	SK Clock Frequency	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	(Note 4)	0	OMITY	MHz
^t skH	SK High Time	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	COMITY W	250 300	COM.	√ ns
^t skL	SK Low Time	TW WWW	M.Co. TAI	250	Y.C.	ns
^t sks	SK Setup Time	MIW WWW.I	SK must be at V _{IL} for t _{SKS} before CS goes high	50	ON.COM	ns
tcs	Minimum CS Low Time	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	(Note 2)	250 250	100X.CO	ns

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

WWW.100Y.COM.TW

DC and AC Electrical Characteristics $V_{CC} = 5.0V \pm 10\%$ (unless otherwise specified) (Continued)

Symbol	Parameter	Part Number	Conditions	Min	Max	Units
t _{CSS} CS Setup Time		NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	N.COWITA	50 50		ns
toH W	D0 Hold Time	CONT. MAN.	OOY.CO.	70		ns
t _{DIS}	DI Setup Time	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	100A'COW'L	100 200		ns
tcsh	CS Hold Time	E. COW. I.	1.100° COM.	0		ns
t _{DIH}	DI Hold Time	OF CONTRACT AND	W.100 COM	20		ns
t _{PD1}	Output Delay to "1"	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V	1M:100X:CO2	M.TW	500 500	ns
t _{PD0}	Output Delay to "0"	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V		OM.TW	500 500	ns
tsv	CS to Status Valid	NM93C06-NM93C66 NM93C06E/V-NM93C66E/V		COM^T	500 500	ns
t _{DF} CS to DO in NM93C06-NM93C66 TRI-STATE® NM93C06E/V-NM93C66E/V		CS = V _{IL}	Y.COM.	100 100	ns	
t _{WP}	Write Cycle Time	AMM. 100X.CO. T.M.	MALL	OVICE	10	ms

Capacitance

 $T_A = 25^{\circ}C f = 1 MHz$

Symbol	Test	Тур	Max	Units
COUT	Output Capacitance		5	pF
CIN	Input Capacitance	N	5 🕦	pF

Note 1: Stress ratings above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and operation of the device at these or any other conditions above those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: CS (Chip Select) must be brought low (to V_{1U}) for an interval of t_{CS} in order to reset all internal device registers (device reset) prior to beginning another opcode cycle (This is shown in the opcode diagrams in the following pages).

Note 3: Typical leakage values are in the 20 nA range.

Note 4: The shortest allowable SK clock period = $1/f_{SK}$ (as shown under the f_{SK} parameter). Maximum SK clock speed (minimum SK period) is determined by the interaction of several AC parameters stated in the datasheet. Within this SK period, both t_{SKH} and t_{SKL} limits must be observed. Therefore, it is not allowable to set $1/f_{SK} = t_{SKHminimum} + t_{SKLminimum}$ for shorter SK cycle time operation.

AC Test Conditions

V _{CC} Range	V _{IL} /V _{IH} Input Levels	V _{IL} /V _{IH} Timing Level	V _{OL} /V _{OH} Timing Level	I _{OL} /I _{OH}
$4.5V \le V_{CC} \le 5.5V$ (TTL Levels)	0.4V/2.4V	1.0V/2.0V	0.4V/2.4V	-2.1 mA/0.4 mA

Output Load: 1 TTL Gate (CL = 100 pF)

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Functional Description

The NM93C06/C46/C56/C66 devices have 7 instructions as described below. Note that the MSB of any instruction is a "1" and is viewed as a start bit in the interface sequence. For the C06 and C46 the next 8 bits carry the op code and the 6-bit address for register selection. For the C56 and C66 the next 10-bits carry the op code and the 8-bit address for register selection.

All Data in signals are clocked into the device on the low-tohigh SK transition.

Read (READ):

The READ instruction outputs serial data on the DO pin. After a READ instruction is received, the instruction and address are decoded, followed by data transfer from the selected memory register into a 16-bit serial-out shift register. A dummy bit (logical 0) precedes the 16-bit data output string. Output data changes are initiated by a low to high transition of the SK clock.

Erase/Write Enable (WEN):

When V_{CC} is applied to the part, it powers up in the Erase/Write Disable (WDS) state. Therefore, all programming modes must be preceded by an Erase/Write Enable WEN instruction. Once an Erase/Write Enable instruction is executed, programming remains enabled until an Erase/Write Disable (WDS) instruction is executed or V_{CC} is completely removed from the part.

Erase (ERASE):

The ERASE instruction will program all bits in the selected register to the logical '1' state. CS is brought low following the loading of the last address bit. This falling edge of the CS pin initiates the self-timed programming cycle.

The DO pin indicates the READY/BUSY status of the chip if CS is brought high after the t_{CS} interval. DO = logical '0' indicates that programming is still in progress. DO = logical

'1' indicates that the register, at the address specified in the instruction, has been erased, and the part is ready for another instruction.

Write (WRITE):

The WRITE instruction is followed by 16 bits of data to be written into the specified address. After the last bit of data is put on the data-in (DI) pin, CS must be brought low before the next rising edge of the SK clock. This falling edge of CS initiates the self-timed programming cycle. The DO pin indicates the READY/BUSY status of the chip if CS is brought high after the $t_{\rm CS}$ interval. DO = logical 0 indicates that programming is still in progress. DO = logical 1 indicates that the register at the address specified in the instruction has been written with the data pattern specified in the instruction and the part is ready for another instruction.

Erase All (ERAL):

The ERAL instruction will simultaneously program all registers in the memory array and set each bit to the logical '1' state. The Erase All cycle is identical to the ERASE cycle except for the different op-code. As in the ERASE mode, the DO pin indicates the READY/BUSY status of the chip if CS is brought high after the t_{CS} interval.

Write All (WRALL):

The WRALL instruction will simultaneously program all registers with the data pattern specified in the instruction. As in the WRITE mode, the DO pin indicates the READY/BUSY status of the chip if CS is brought high after the t_{CS} interval.

Write Disable (WDS):

To protect against accidental data disturb, the WDS instruction disables all programming modes and should follow all programming operations. Execution of a READ instruction is independent of both the WEN and WDS instructions.

NOTE: The NSC CMOS EEPROMs do not require an 'ERASE' or 'ERASE ALL' operation prior to the 'WRITE' and 'WRITE ALL' instructions. The 'ERASE' and 'ERASE ALL' instructions are included to maintain compatibility with earlier technology EEPROMs.

Instruction Set for the NM93C06 and NM93C46

Instruction	SB	Op Code	Address	Data	Comments
READ	1	10 10	A5-A0	W 100	Reads data stored in memory, at specified address.
WEN	WW	00	11XXXX	W 10	Enable all programming modes.
ERASE	11	10011.00	A5-A0	WW	Erase selected register.
WRITE	JUW	01	A5-A0	D15-D0	Writes selected register.
ERAL	1	00	10XXXX	WWW	Erases all registers.
WRALL	1	00	01XXXX	D15-D0	Writes all registers.
WDS	1	00	00XXXX		Disables all programming modes.

Note: Address bits A5 and A4 become "Don't Care" for the NM93C06.

Instruction Set for the NM93C56 and NM93C66

Instruction	SB	Op Code	Address	Data	Comments
READ	1	10	A7-A0		Reads data stored in memory, at specified address.
WEN	1	00	11XXXXXX	L.M.	Enable all programming modes.
ERASE	1	11	A7-A0	WT	Erase selected register.
ERAL	1	00	10XXXXXX	W	Erases all registers.
WRITE	1	01	A7-A0	D15-D0	Writes selected register.
WRALL	1	00	01XXXXXX	D15-D0	Writes all registers.
WDS	1	00	00XXXXXX	OM.	Disables all programming modes.

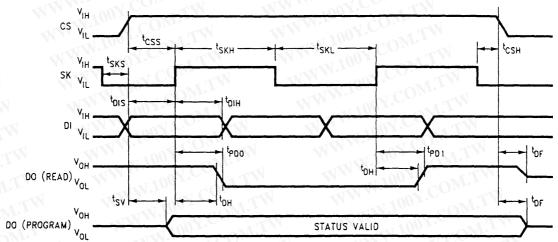
Note: Address bit A7 becomes "Don't Care" for the NM93C56

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

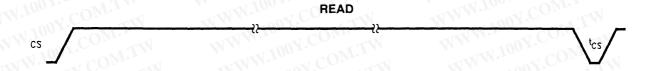


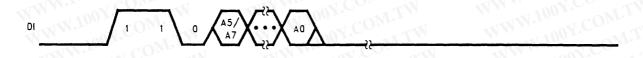


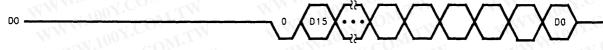
Synchronous Data Timing



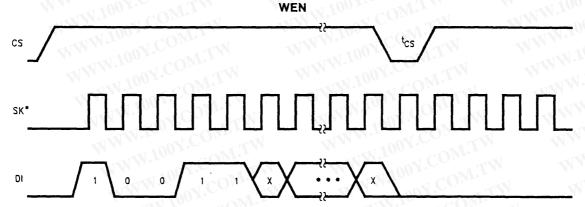
TL/D/10751-4







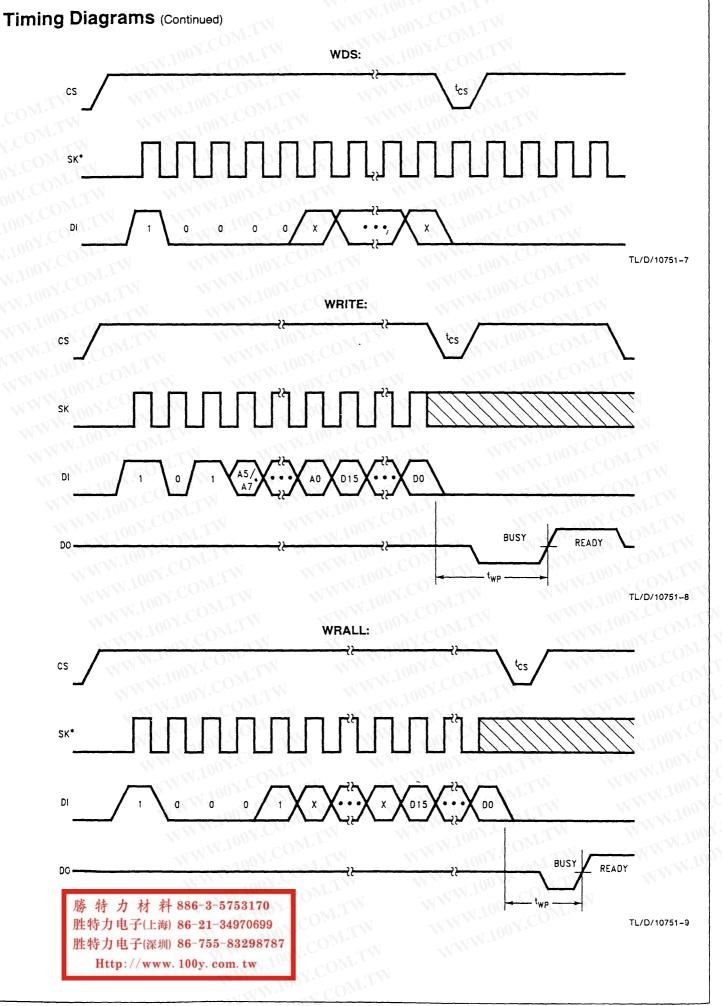
TL/D/10751-5



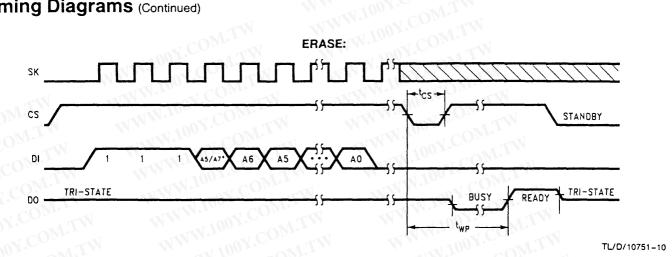
TL/D/10751-6

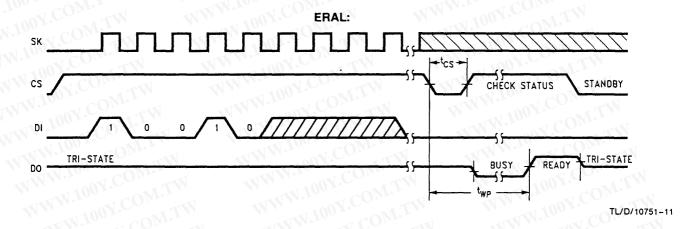
勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787

Http://www.100y.com.tw



Timing Diagrams (Continued)





WWW.100Y.COM.TW 特力材料886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw

WWW.100Y.COM.T